

Spread Spectrum Clock Generator

Features

- Generates four 4X low EMI spread spectrum clocks
- Input frequency: 15MHz
- Output frequency: 60MHz
- Internal loop filter minimizes external components and board space
- Selectable Centre Spread frequency deviation:
 $\pm 0.5\%$, $\pm 0.75\%$, $\pm 1.0\%$,
 $\pm 1.25\%$, $\pm 1.5\%$, $\pm 1.75\%$ $\pm 2.0\%$
- $3.3V \pm 0.3V$ Operating Voltage
- Commercial Temperature range
- Available in 16-pin TSSOP
- Advanced low power CMOS process

offers seven selectable centre spread options of $\pm 0.5\%$ to $\pm 2.0\%$, and a no spread option. (Refer Spread Deviation Selection Table). PCS3P2191A reduces electromagnetic interference (EMI) at the clock source, allowing system wide reduction of EMI of all clock dependent signals. The PCS3P2191A allows significant system cost savings by reducing the number of circuit board layers, ferrite beads, and shielding that are traditionally required to pass EMI regulations. The PCS3P2191A uses the most efficient and optimized modulation profile approved by the FCC and is implemented in a proprietary all digital method.

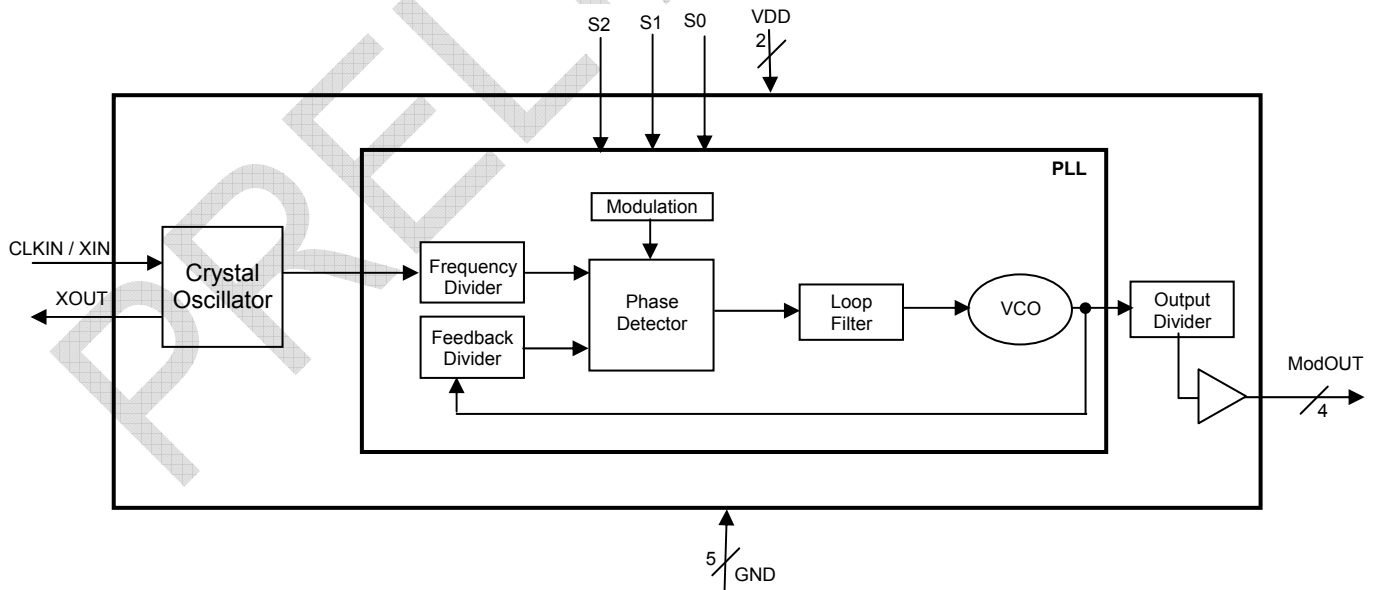
Product Description

PCS3P2191A is a versatile spread spectrum frequency modulator that generates four low EMI 4x clocks at the output. PCS3P2191A

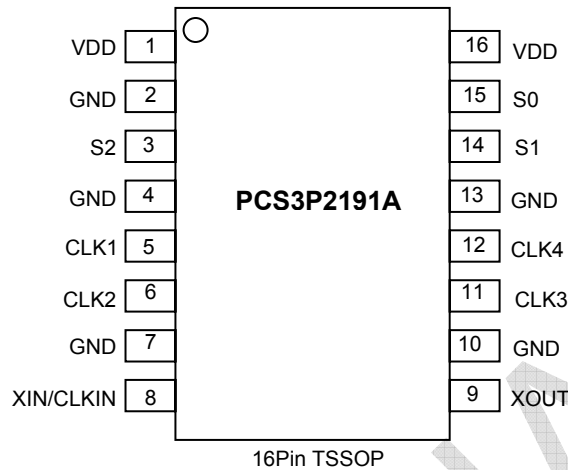
Application

PCS3P2191A is targetted for LCD panel application

Block Diagram



Pin Configuration



Pin Description

Pin#	Pin Name	Type	Description
1	VDD	power	Power Supply Voltage Pin. Connect to +3.3V.
2	GND	power	Ground Connection. Connect to system ground.
3	S2	Input	Spread range select. Digital logic input used to select frequency deviation (Refer <i>Spread Deviation Table</i>). This pin has an internal pull-up resistor.
4	GND	power	Ground Connection. Connect to system ground.
5	CLK1	Output	Low EMI 4x clock output.
6	CLK2	Output	Low EMI 4x clock output.
7	GND	power	Ground Connection. Connect to system ground.
8	XIN/CLKIN	Input	Crystal connection or external reference frequency input. It can be connected to a 15MHz fundamental mode crystal.
9	XOUT	Output	Crystal connection. If using an external reference, this pin must be left unconnected.
10	GND	power	Ground Connection. Connect to system ground.
11	CLK3	Output	Low EMI 4x clock output.
12	CLK4	Output	Low EMI 4x clock output.
13	GND	power	Ground Connection. Connect to system ground.
14	S1	Output	Spread range select. Digital logic input used to select frequency deviation (Refer <i>Spread Deviation Table</i>). This pin has an internal pull-up resistor.
15	S0	Output	Spread range select. Digital logic input used to select frequency deviation (Refer <i>Spread Deviation Table</i>). This pin has an internal pull-up resistor.
16	VDD	power	Power Supply Voltage Pin. Connect to +3.3V.

rev 0.1

Spread Deviation Selection Table

S2	S1	S0	Deviation
0	0	0	OFF
0	0	1	± 0.5%
0	1	0	± 0.75%
0	1	1	± 1.0%
1	0	0	± 1.25%
1	0	1	± 1.5%
1	1	0	± 1.75%
1	1	1	± 2.0%

Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
VDD	Supply Voltage pin with respect to Ground	-0.5 to +4.6	V
V _{IN}	Input Voltage pin with respect to Ground	VSS-0.5 to VDD+0.5	V
V _{OUT}	Output Voltage pin with respect to Ground	VSS-0.5 to VDD+0.5	V
T _{STG}	Storage temperature	-55 to +125	°C
T _s	Max. Soldering Temperature (10 sec)	260	°C
T _J	Junction Temperature	150	°C
T _{DV}	Static Discharge Voltage(As per JEDEC STD22- A114-B)	2	KV

Note: These are stress ratings only and are not implied for functional use. Exposure to absolute maximum ratings for prolonged periods of time may affect device reliability.

Recommended Operating Conditions

Parameter	Description	Min	Typ	Max	Unit
VDD	Operating Voltage	3.0	3.3	3.6	V
T _A	Operating Temperature (Ambient Temperature)	0		+70	°C
C _L	Load Capacitance			15	pF
C _{IN}	Input Capacitance		5		pF

DC Electrical Characteristics

Symbol	Parameter		Min	Typ	Max	Unit
V _{IL}	Input low voltage		VSS – 0.3		0.8	V
V _{IH}	Input high voltage		2.0		VDD+ 0.3	V
I _{IL}	Input low current				-35	μA
I _{IH}	Input high current				+35	μA
I _{XOL}	X _{OUT} output low current (V _{XOL} @ 0.4V, VDD = 3.3V)			3		mA
I _{XOH}	X _{OUT} output high current (V _{XOH} @ 2.5V, VDD = 3.3V)			3		mA
V _{OL}	Output low voltage	I _{OL} = 12mA	VSS		0.4	V
V _{OH}	Output high voltage	I _{OH} = -12mA	2.5		VDD	V
I _{CC}	Dynamic supply current , 60 MHz Output, no load			TBD		mA
I _{DD}	Static supply current standby mode*				TBD	uA
VDD	Operating voltage		3.0	3.3	3.6	V
t _{ON}	Power up time (first locked clock cycle after power up)**				5	mS
Z _{OUT}	Clock output impedance			TBD		Ω
C _{IN}	Input Capacitance			5		pF
C _L	Load Capacitance				15	pF

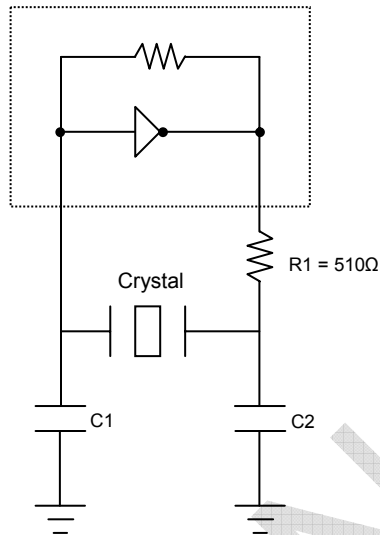
*CLKIN pulled Low
 **VDD and CLKIN inputs are stable

AC Electrical Characteristics

Symbol	Parameter		Min	Typ	Max	Unit
XIN/ CLKIN	Input frequency			15		MHz
CLKOUT	Output frequency	(Pin 5,6,11,12)		60(SS)		MHz
t _{LH} *	Output rise time (Measured from 20% to 80%)			TBD		nS
t _{HL} *	Output fall time (Measured from 80% to 20%)			TBD		nS
t _{JC} *	Cycle to cycle Jitter			TBD		pS
t _D *	Output duty cycle		45	50	55	%

*t_{LH} and t_{HL} are measured with a capacitive load of 15pF

Typical Crystal Oscillator Circuit

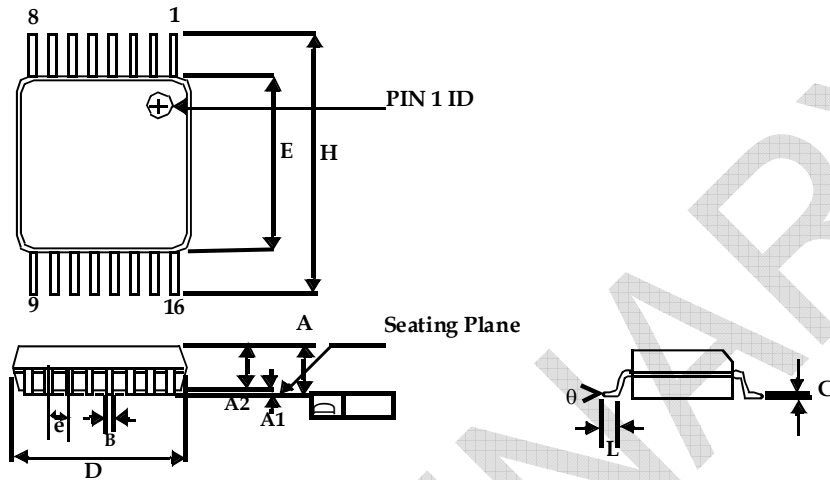


Typical Crystal Specifications

Fundamental AT cut parallel resonant crystal	
Nominal frequency	15MHz
Frequency tolerance	± 50 ppm or better at 25°C
Operating temperature range	-25°C to +85°C
Storage temperature	-40°C to +85°C
Load capacitance	18pF
Shunt capacitance	7pF maximum
ESR	25Ω

Package Information

16-lead Thin Shrink Small Outline Package (4.40-MM Body)



Symbol	Dimensions			
	Inches		Millimeters	
	Min	Max	Min	Max
A		0.043		1.20
A1	0.002	0.006	0.05	0.15
A2	0.031	0.041	0.80	1.05
B	0.007	0.012	0.19	0.30
C	0.004	0.008	0.09	0.20
D	0.193	0.201	4.90	5.10
E	0.169	0.177	4.30	4.50
e	0.026 BSC		0.65 BSC	
H	0.252 BSC		6.40 BSC	
L	0.020	0.030	0.50	0.75
θ	0°	8°	0°	8°

Ordering Codes

Part Number	Marking	Package Type	Temperature
PCS3P2191AG-16TT	3P2191AG	16-Pin TSSOP, TUBE, Green	Commercial
PCS3P2191AG-16TR	3P2191AG	16-Pin TSSOP, TAPE & REEL, Green	Commercial
PCS3P2191AF-16TT	3P2191AF	16-Pin TSSOP, TUBE, Pb Free	Commercial
PCS3P2191AF-16TR	3P2191AF	16-Pin TSSOP, TAPE & REEL, Pb Free	Commercial

Device Ordering Information

PCS3P2191AG - 16TR

R = Tape & Reel, T = Tube or Tray

O = TSOT23	U = MSOP	J=TSOT26
S = SOIC	E = TQFP	
T = TSSOP	L = LQFP	
A = SSOP	U = MSOP	
V = TVSOP	P = PDIP	
B = BGA	D = QSOP	
Q = QFN	X = SC-70	

DEVICE PIN COUNT

G = GREEN PACKAGE, LEAD FREE, and RoHS

PART NUMBER

X= Automotive (-40C to +125C)	I= Industrial (-40C to +85C)	P or n/c = Commercial (0C to +70C)
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1 = Reserved	6 = Power Management
2 = Non PLL based	7 = Power Management
3 = EMI Reduction	8 = Power Management
4 = DDR support products	9 = Hi Performance
5 = STD Zero Delay Buffer	0 = Reserved

PulseCore Semiconductor Mixed Signal Product

Licensed under U.S Patent Nos 5,488,627 and 5,631,921



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Note: This product utilizes US Patent # 6,646,463 Impedance Emulator Patent issued to PulseCore Semiconductor, dated 11-11-2003

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